

VS-MBR6045WTPbF, VS-MBR6045WT-N3

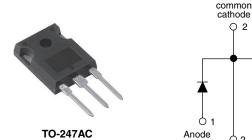
Vishay Semiconductors

Schottky Rectifier, 2 x 30 A

Base

Common cathode

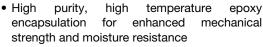
Anode



PRODUCT SUMMARY					
Package	TO-247AC				
I _{F(AV)}	2 x 30 A				
V_{R}	45 V				
V _F at I _F	0.55 V				
I _{RM} max.	150 mA at 125 °C				
T_J max.	150 °C				
Diode variation	Common cathode				
E _{AS}	27 mJ				
	•				

FEATURES

- 150 °C T_J operation
- Very low forward voltage drop
- High frequency operation





- Guard ring for enhanced ruggedness and long term reliability
- Compliant to RoHS Directive 2002/95/EC
- Designed and qualified according to JEDEC-JESD47
- Halogen-free according to IEC 61249-2-21 definition (-N3 only)

DESCRIPTION

The VS-MBR6045WT... center tap Schottky rectifier has been optimized for very low forward voltage drop, with moderate leakage. The proprietary barrier technology allows for reliable operation up to 150 °C junction temperature. Typical applications are in switching power supplies, converters, freewheeling diodes, and reverse battery protection.

MAJOR RATINGS AND CHARACTERISTICS							
SYMBOL	CHARACTERISTICS	VALUES	UNITS				
I _{F(AV)}	Rectangular waveform	60	Α				
V _{RRM}		45	V				
I _{FSM}	t _p = 5 μs sine	2900	Α				
V _F	30 Apk, T _J = 125 °C (per leg)	0.55	V				
T _J		- 55 to 150	°C				

VOLTAGE RATINGS							
PARAMETER SYMBOL VS-MBR6045WTPbF VS-MBR6045WT-N3 UNITS							
Maximum DC reverse voltage	V _R	45	45	V			
Maximum working peak reverse voltage	V _{RWM}	40	45	V			

ABSOLUTE MAXIMUM RATINGS						
PARAMETER		SYMBOL	TEST COND	VALUES	UNITS	
Maximum average	per leg		50 % duty cycle at T _C = 122 °C, rectangular waveform		30	
forward current See fig. 5	per device	I _{F(AV)}			60	А
Maximum peak one cycle non-repetitive surge current per leg See fig. 7		l=	5 μs sine or 3 μs rect. pulse	Following any rated load condition and with rated	2900	
		IFSM	10 ms sine or 6 ms rect. pulse	V _{RRM} applied	360	
Non-repetitive avalanche ene	rgy per leg	E _{AS}	$T_J = 25$ °C, $I_{AS} = 4$ A, $L = 3.4$ mH		27	mJ
Repetitive avalanche current p	per leg	I _{AR}	Current decaying linearly to zero in 1 μ s Frequency limited by T _J maximum V _A = 1.5 x V _R typical		6	Α



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ELECTRICAL SPECIFICATIONS						
PARAMETER	SYMBOL	TEST CONDITIONS		VALUES	UNITS	
		30 A	T _{.1} = 25 °C	0.62	V	
Maximum forward voltage drop per leg See fig. 1	V _{FM} (1)	60 A	11=23 0	0.75		
See lig. 1		30 A	T _J = 125 °C	0.55		
Maximum reverse leakage current per leg	I _{RM} ⁽¹⁾	T _J = 25 °C	- V _R = Rated V _R	1	mA	
See fig. 2		T _J = 125 °C		150		
Threshold voltage	V _{F(TO)}	T - T movimum		0.27	٧	
Forward slope resistance	r _t	$T_J = T_J$ maximum		7.3	mΩ	
Maximum junction capacitance per leg	C _T	$V_R = 5 V_{DC}$ (test signal range 100 kHz to 1 MHz) 25 °C		1400	pF	
Typical series inductance per leg	L _S	Measured lead to lead 5 m	7.5	nΗ		
Maximum voltage rate of change	dV/dt	Rated V _R	10 000	V/µs		

Note

 $^{^{(1)}}$ Pulse width < 300 μ s, duty cycle < 2 %

THERMAL - MECHANICAL SPECIFICATIONS						
PARAMETER		SYMBOL	TEST CONDITIONS	VALUES	UNITS	
Maximum junction and storage temperature range		T _J , T _{Stg}		- 55 to 150	°C	
Maximum thermal resistance, junction to case per leg		D	DC operation See fig. 4	1.0		
Maximum thermal resistance, junction to case per package		R_{thJC}	DC operation	0.5	°C/W	
Typical thermal resistance, case to heatsink		R _{thCS}	Mounting surface, smooth and greased	0.24		
Approximate weight				6	g	
Approximate weight				0.21	OZ.	
Mounting torque —	minimum			6 (5)	kgf · cm	
	maximum			12 (10)	(lbf \cdot in)	
Marking device			Case style TO-247AC (JEDEC)	MBR60	045WT	

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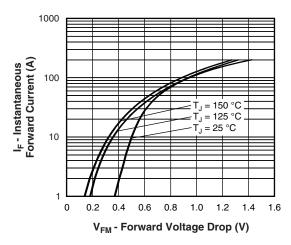


Fig. 1 - Maximum Forward Voltage Drop Characteristics (Per Leg)

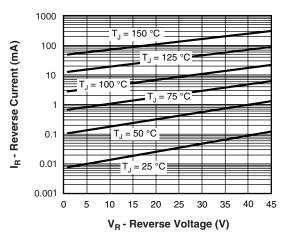


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage (Per Leg)

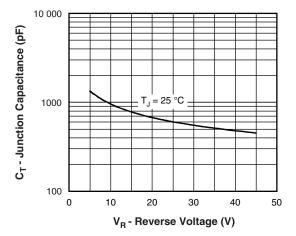


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage (Per Leg)

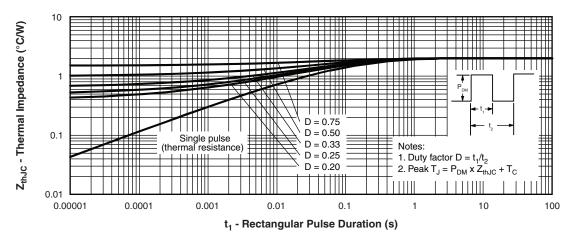


Fig. 4 - Maximum Thermal Impedance ZthJC Characteristics (Per Leg)

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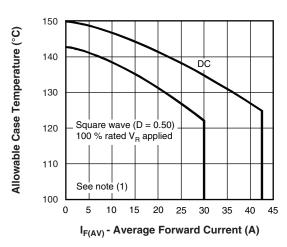


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current (Per Leg)

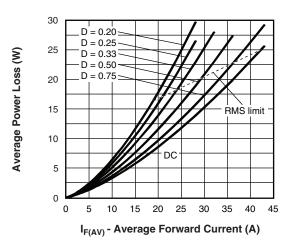


Fig. 6 - Forward Power Loss Characteristics (Per Leg)

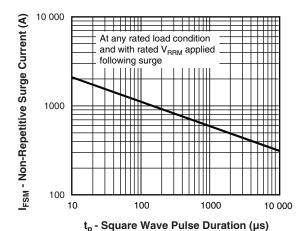


Fig. 7 - Maximum Non-Repetitive Surge Current (Per Leg)

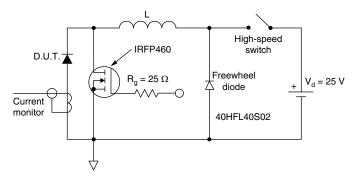


Fig. 8 - Unclamped Inductive Test Circuit

Note

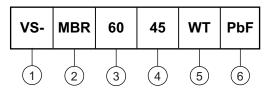
(1) Formula used: T_C = T_J - (Pd + Pd_{REV}) x R_{thJC}; Pd = Forward power loss = I_{F(AV)} x V_{FM} at (I_{F(AV)}/D) (see fig. 6); Pd_{REV} = Inverse power loss = V_{R1} x I_R (1 - D); I_R at V_{R1} = 100 % rated V_R

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ORDERING INFORMATION TABLE

Device code



1 - Vishay Semiconductors product

2 - Schottky MBR series

Current rating (60 = 60 A)

Voltage rating (45 = 45 V)

5 - Circuit configuration:

6 Center tap (dual) TO-247

7 - Environmental digit

• PbF = Lead (Pb)-free and RoHS compliant

• -N3 = Halogen-free, RoHS compliant, and totally lead (Pb)-free

ORDERING INFORMATION (Example)							
PREFERRED P/N	QUANTITY PER T/R	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION				
VS-MBR6045WTPbF	25	500	Antistatic plastic tube				
VS-MBR6045WT-N3	25	500	Antistatic plastic tube				

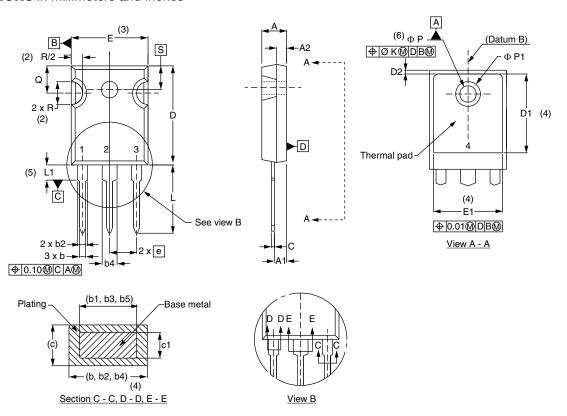
LINKS TO RELATED DOCUMENTS					
Dimensions <u>www.vishay.com/doc?95223</u>					
Dout moulting information	TO-247AC PbF	www.vishay.com/doc?95226			
Part marking information	TO-247AC -N3	www.vishay.com/doc?95007			



Vishay Semiconductors

TO-247AC

DIMENSIONS in millimeters and inches



SYMBOL	MILLIN	IETERS	INC	HES	NOTES
STWIDGE	MIN.	MAX.	MIN.	MAX.	NOTES
Α	4.65	5.31	0.183	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b1	0.99	1.35	0.039	0.053	
b2	1.65	2.39	0.065	0.094	
b3	1.65	2.34	0.065	0.092	
b4	2.59	3.43	0.102	0.135	
b5	2.59	3.38	0.102	0.133	
С	0.38	0.89	0.015	0.035	
c1	0.38	0.84	0.015	0.033	
D	19.71	20.70	0.776	0.815	3
D1	13.08	-	0.515	-	4

SYMBOL	MILLIM	IETERS	INC	INCHES		
STWIDOL	MIN.	MAX.	MIN.	MAX.	NOTES	
D2	0.51	1.30	0.020	0.051		
E	15.29	15.87	0.602	0.625	3	
E1	13.72	-	0.540	-		
е	5.46	BSC	0.215	BSC		
ØΚ	2.54		0.0	10		
L	14.20	16.10	0.559	0.634		
L1	3.71	4.29	0.146	0.169		
ØΡ	3.56	3.66	0.14	0.144		
Ø P1	-	6.98	-	0.275		
Q	5.31	5.69	0.209	0.224		
R	4.52	5.49	0.178	0.216		
S	5.51 BSC		0.217	BSC		

Notes

- (1) Dimensioning and tolerancing per ASME Y14.5M-1994
- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. Mold flash shall not exceed 0.127 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body
- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1
- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension c



Legal Disclaimer Notice

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